

Product Change Notification (PCN)

Title	DDR4 product change notice from Micron 8Gb E-die UT IC to R-die UT IC	Date	2023/12/15	No.	231215-2				
Models	DDR4 Ultra Temperature DRAM Modules								
Level	Major	Hardware - IC							
Description									
Key Characteristics of the Change: Due to supply conditions, Innodisk hereby announces the product change plan for DDR4 Micron 1Gx8 E-die IC assembled Ultra Temperature modules.									
Description:									
<table><tr><th>Old</th><th>New</th></tr><tr><td>Micron DDR4-3200 1Gx8 E-die (-40~+125 <i>degrees Celsius</i>) MT40A1G8SA-062E AUT:E</td><td>Micron DDR4-3200 1Gx8 R-die (-40~+125 <i>degrees Celsius</i>) MT40A1G8AG-062E AUT:R</td></tr></table>						Old	New	Micron DDR4-3200 1Gx8 E-die (-40~+125 <i>degrees Celsius</i>) MT40A1G8SA-062E AUT:E	Micron DDR4-3200 1Gx8 R-die (-40~+125 <i>degrees Celsius</i>) MT40A1G8AG-062E AUT:R
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Affected Component Table	
Current Part Number	New Part Number
M4DE-8GM1PE0M-E%	M4DE-8GM1PE0M-R
M4DE-AGM1QE0M-E%	M4DE-AGM1QE0M-R
M4SE-8GM1NE0M-E%	M4SE-8GM1NE0M-R
M4SE-AGM1OE0M-E%	M4SE-AGM1OE0M-R

Key Milestone Dates	
Last Purchase Date	2024/3/31
Last Shipment Date	2024/6/30
*Implement from: based on business and operational conditions	

Note
(1) For the availability of the replacement samples, please talk to the salesperson and the local PM. (2) No response from customers will be deemed as acceptance of the change, which will be implemented according to the key milestones. Innodisk apologizes for any inconvenience caused by this and appreciates your understanding. (3) Innodisk promises that new items deliver quality and reliability, and are JEDEC compliant. If there is any further inquiry about our products or product specifications, please contact your Innodisk salesperson for support. (4) Innodisk reserves the right to process the product change if the PN is not listed. (5) The wild cards are represented here by percentage (%).

Director, SYLVIA CHENG
Embedded DRAM Div.

